

# Irradiation test on FD-SOI Readout ASIC of Pair-monitor for ILC

## **Presented by Yutaro Sato**

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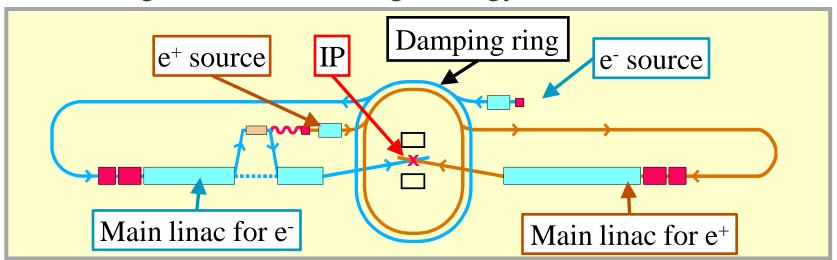
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## **International Linear Collider**

ILC is a next generation of the high-energy e<sup>+</sup> e<sup>-</sup> collider.



#### **Purposes**

- Study higgs sector
- Search new physics

#### **Parameters**

- CM energy: 500 GeV (upgrade to 1 TeV)
- Integrated luminosity (4 years): 500 fb-1
- Beam size

$$(\sigma_x, \sigma_v, \sigma_z) = (639 \text{ nm}, 5.7 \text{ nm}, 300 \text{ }\mu\text{m})$$

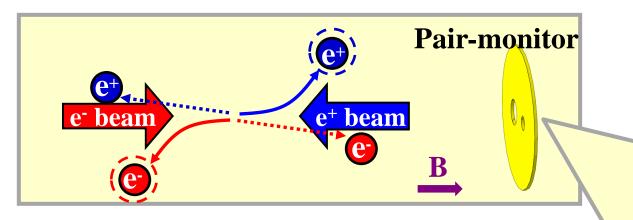
→ Beam Profile monitor is necessary to keep the high luminosity.



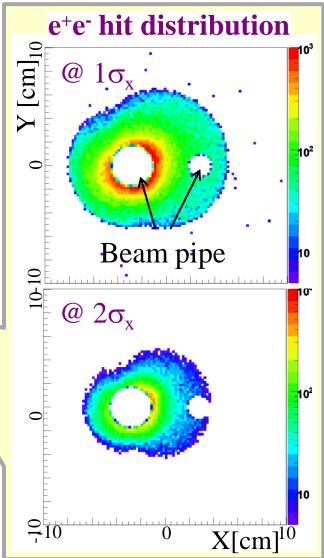
## **Pair-monitor**

Pair-monitor is a silicon pixel detector to measure the beam profile at IP.

- The distribution of the pair B.G. is used.
  - The same charges with respect to the oncoming beam are scattered with large angle.
  - The scattered particles have information on beam shape.



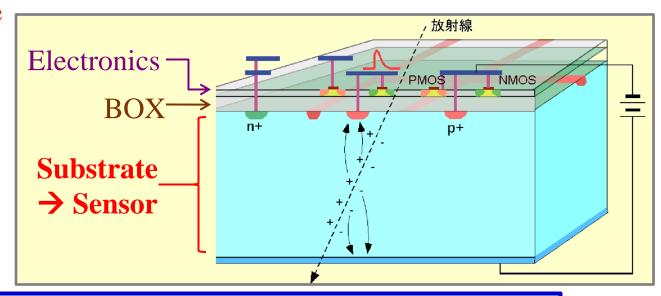
The beam size can be derived from the pair B.G. distribution.



The pair-monitor is developed using the SOI technology.

#### **SOI** (Silicon On Insulator) pixel detector

- SOI pixel group at KEK is currently developing.
- The sensor and electronics are integrated in a SOI wafer.
  - Monolithic device
  - High speed
  - Low power
  - > Thin device
  - Low material



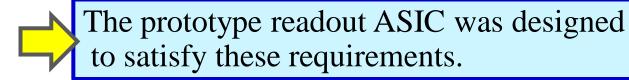
- The prototype ASIC for the pair-monitor was fabricated via the MPW Run organized by the SOI pixel group.
- This prototype is not monolithic (Substrate is not a sensor).

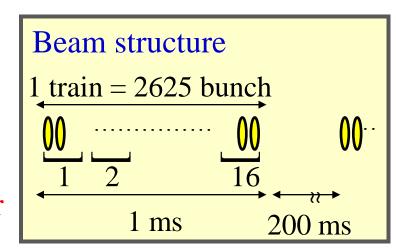
## Requirement to readout ASIC

#### Required performance

- 1. Time resolution : < 260 nsec
  - (less than bunch space)
- 2. Noise level : < 1000 e

  (typical signal level : 15,000 e)
- 3. Radiation tolerance : > a few Mrad/year
- 4. Time-dependent measurement
  - Measure the pixel hit count in 16 time slice per train,
     and hit counts are read out during the inter-train gap of 200 ms.





## **Prototype readout ASIC**

**Analogue circuit** 

Comparator

8 bit counter

• Process : FD-SOI CMOS 0.20 μm

Offset voltage

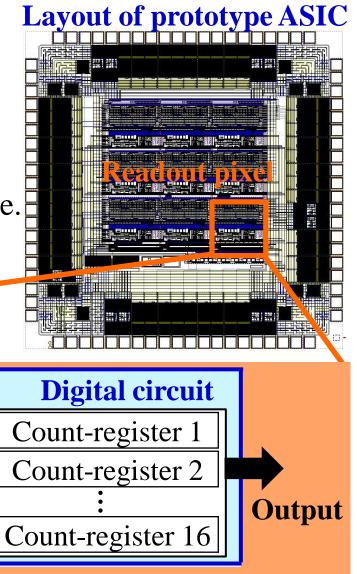
trimming circuit

- Chip size : 2.5 x 2.5 mm<sup>2</sup>
- # of pixels : 9 (3x3)

Input

Amp.

- Pixel size : 390 x 350 μm<sup>2</sup>
- Each pixel has different detector capacitance.



## **Irradiation test**

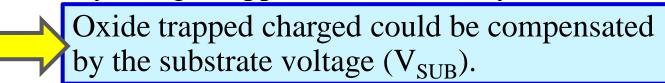
Irradiation test was performed to test the radiation tolerance

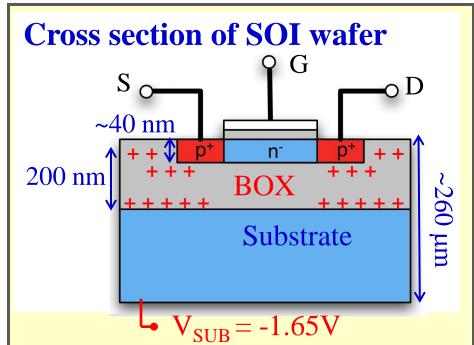
and observe the radiation effect.

- X-ray generator : Rigaku FR-D
  - Target : Cu (~ 8 keV photon)
- Doses: up to 2 Mrad

#### **Radiation effect**

- Single event effect (SEE)
  - Caused by single energetic particle.
  - → SOI device is known as rad-hard for SEE
- Total dose effect (TDE)
  - Caused by charge trapped in the oxide layer.

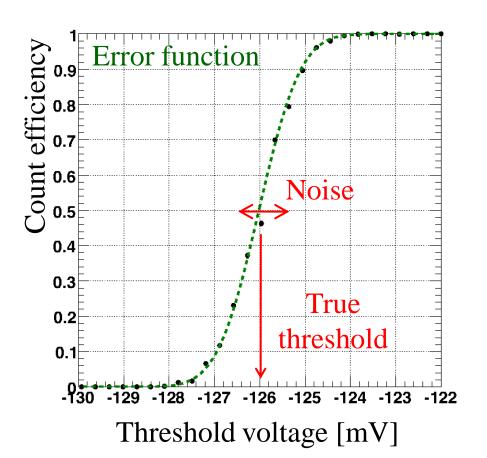


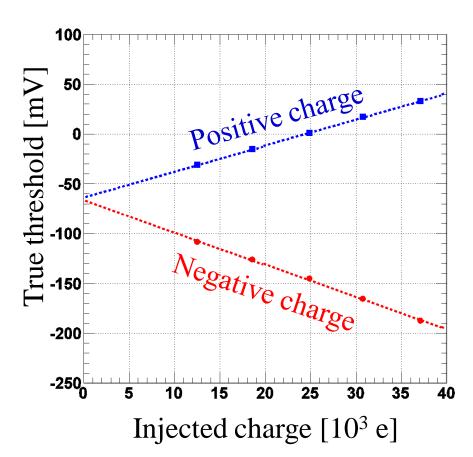


(design value)

## Measurements

- Signal shape at pre-amplifier
- Gain
- Linearity
- Noise level

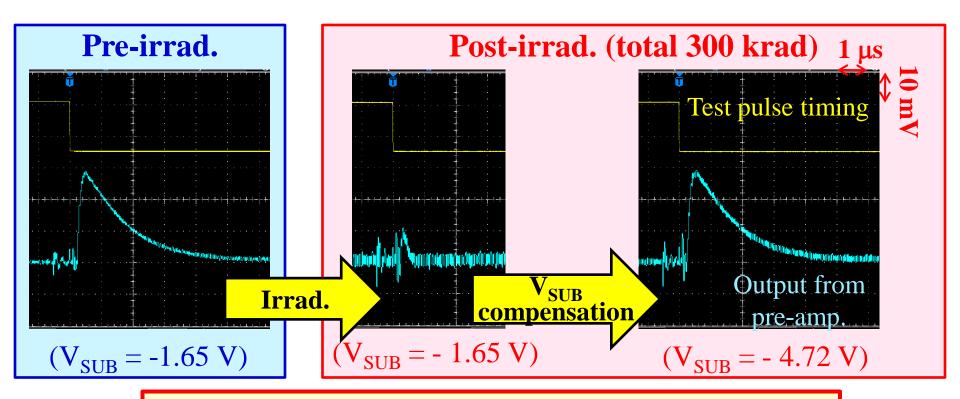




## Signal shape

The signal shape at the pre-amp. was compared.

• By irradiation, the signal shape becomes smaller and vanished at the post-irrad. of larger 1 Mrad.

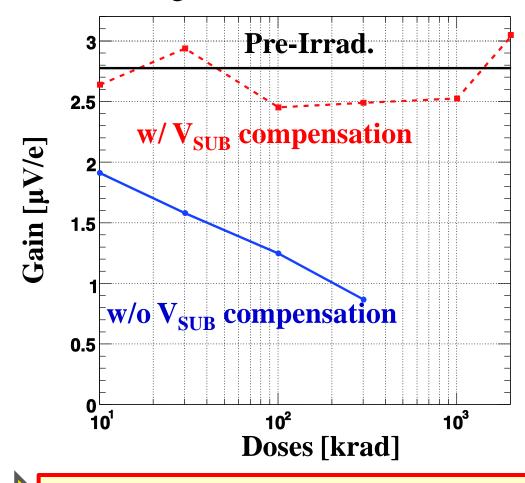


The signal shape of post-irradiation can be returned to that of pre-irradiation by  $V_{SUB}$  compensation.

## Gain

The gain was compared.

• By the irradiation, the gain becomes smaller.



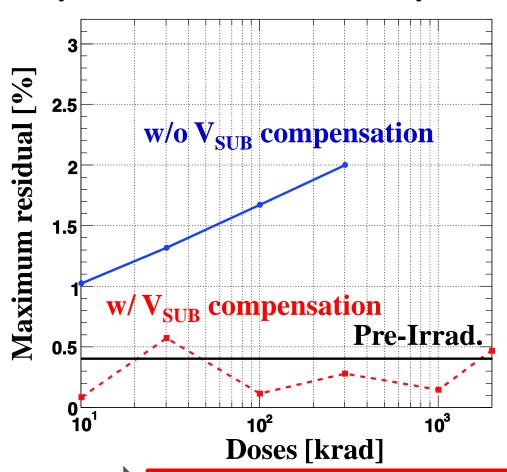


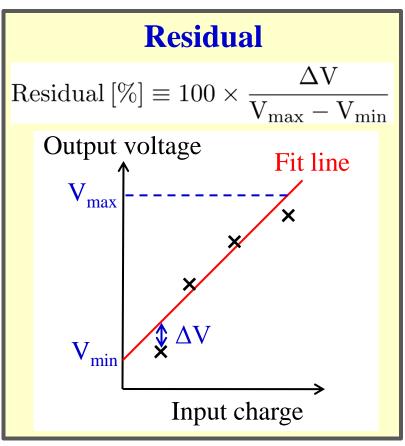
## Linearity

The linearity was compared.

(fitting region :  $7,000 \sim 45,000 e$ )

• By the irradiation, the linearity becomes worse.



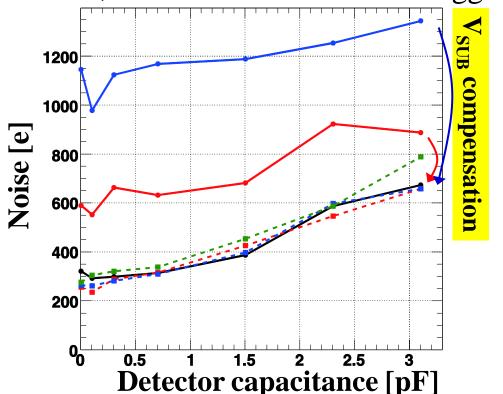


The linearity can be restored by V<sub>SUB</sub> compensation.

#### **Noise level**

The noise level was compared.

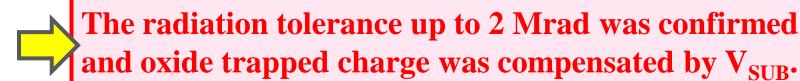
• By irradiation, the noise level becomes bigger.



Pre-Irrad.
Post-Irrad. (100krad)
Post-Irrad. (300krad)
Post-Irrad. (2Mrad)

★ Dashed line means w/ V<sub>SUB</sub> compensation.

The noise level returns to that of pre-irrad. by the V<sub>SUB</sub> compensation.



## **Summary**

## Pair-monitor is a silicon pixel detector to measure the beam profile at IP and developed with SOI technology.

- The first prototype which is only readout ASIC was produced and the irradiation test was performed successfully.
  - > The radiation tolerance up to 2 Mrad was confirmed.
  - ➤ The oxide trapped charge was compensated by the substrate voltage.

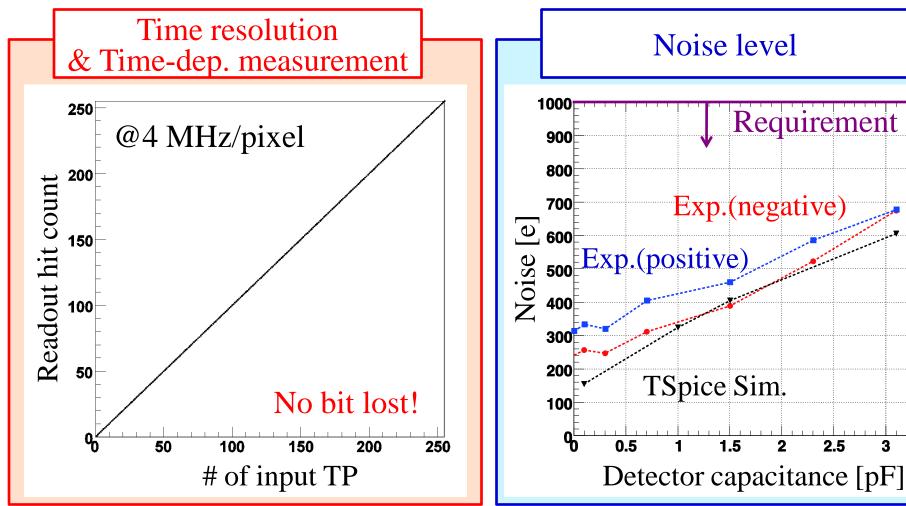
#### Plan

- Investigation into the next prototype
  - Monolithic or hybrid?

## Backup

## **Operation test**

Operation test was performed successfully.



Prototype meets the requirement of time resolution, time-dependent measurement and noise level.

## Radiation doses

**Total Doses = (#photon)** × (**Doses per a photon**)

#### The number of photons

- Evaluated by the photoelectron of diode.
  - $k = 2.5 \times 10^9 [photon/\mu A]$

#### Doses per a photon

- Energy of photon: 8.19 keV
  - Weighted average of K $\alpha$  (8.04 keV) and K $\beta$  (8.91 keV)
  - All the photons are assumed to be absorbed within an attenuation

length ( $\lambda \sim 66 \mu m$ )

• Silicon density  $d = 2.33 \text{ g/cm}^3$ 



## Voltage of substrate voltage (V<sub>SUB</sub>)

